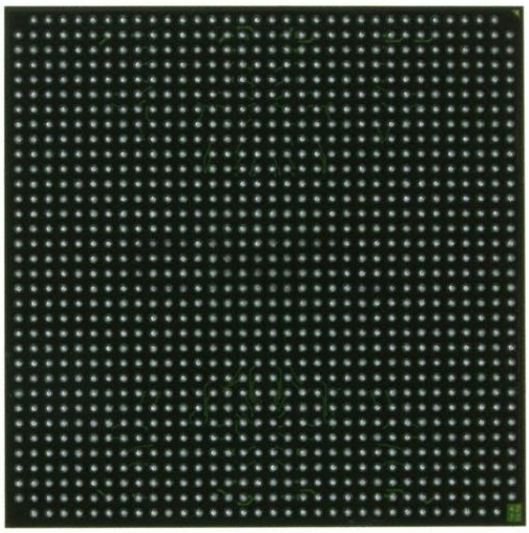

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Details	
Product Status	Obsolete
Number of LABs/CLBs	2320
Number of Logic Elements/Cells	20880
Total RAM Bits	1622016
Number of I/O	564
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BBGA, FCBGA
Supplier Device Package	1152-FCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp20-6ff1152c

Receiver Buffer

The receiver includes buffers (FIFOs) in the datapath. This section gives the reasons for including the buffers and outlines their operation.

The receiver buffer is required for two reasons:

- *Clock correction* to accommodate the slight difference in frequency between the recovered clock RXRECCLK and the internal FPGA user clock RXUSRCLK
- *Channel bonding* to allow realignment of the input stream to ensure proper alignment of data being read through multiple transceivers

The receiver uses an *elastic buffer,* where "elastic" refers to the ability to modify the read pointer for clock correction and channel bonding.

Comma Detection

Word alignment is dependent on the state of comma detect bits. If comma detect is enabled, the transceiver recognizes up to two 10-bit preprogrammed characters. Upon detection of the character or characters, the comma detect output is driven high and the data is synchronously aligned. If a comma is detected and the data is aligned, no further alignment alteration takes place. If a comma is received and realignment is necessary, the data is realigned and an indication is given at the receiver interface. The realignment indicator is a distinct output.

The transceiver continuously monitors the data for the presence of the 10-bit character(s). Upon each occurrence of a 10-bit character, the data is checked for word alignment. If comma detect is disabled, the data is not aligned to any particular pattern. The programmable option allows a user to align data on comma+, comma–, both, or a unique user-defined and programmed sequence.

Clock Correction

RXRECCLK (the recovered clock) reflects the data rate of the incoming data. RXUSRCLK defines the rate at which the FPGA fabric consumes the data. Ideally, these rates are identical. However, since the clocks typically have different sources, one of the clocks will be faster than the other. The receiver buffer accommodates this difference between the clock rates. See Figure 12.

Nominally, the buffer is always half full. This is shown in the top buffer, Figure 12, where the shaded area represents buffered data not yet read. Received data is inserted via the write pointer under control of RXRECCLK. The FPGA fabric reads data via the read pointer under control of RXUSRCLK. The half full/half empty condition of the buffer gives a cushion for the differing clock rates. This operation continues indefinitely, regardless of whether or not "meaningful" data is being received. When there is no meaningful data to be received, the incoming data will consist of IDLE characters or other padding.

If RXUSRCLK is faster than RXRECCLK, the buffer becomes more empty over time. The clock correction logic corrects for this by decrementing the read pointer to reread a repeatable byte sequence. This is shown in the middle buffer, Figure 12, where the solid read pointer decrements to the value represented by the dashed pointer.

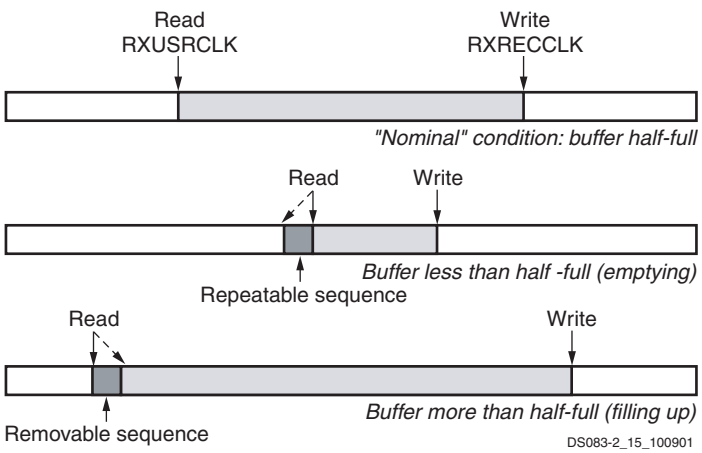

Figure 12: **Clock Correction in Receiver**

By decrementing the read pointer instead of incrementing it in the usual fashion, the buffer is partially refilled. The transceiver design will repeat a single repeatable byte sequence when necessary to refill a buffer. If the byte sequence length is greater than one, and if attribute CLK_COR_REPEAT_WAIT is 0, then the transceiver may repeat the same sequence multiple times until the buffer is refilled to the desired extent.

Similarly, if RXUSRCLK is slower than RXRECCLK, the buffer will fill up over time. The clock correction logic corrects for this by incrementing the read pointer to skip over a removable byte sequence that need not appear in the final FPGA fabric byte stream. This is shown in the bottom buffer, Figure 12, where the solid read pointer increments to the value represented by the dashed pointer. This accelerates the emptying of the buffer, preventing its overflow. The transceiver design will skip a single byte sequence when necessary to partially empty a buffer. If attribute CLK_COR_REPEAT_WAIT is 0, the transceiver may also skip two consecutive removable byte sequences in one step to further empty the buffer when necessary.

These operations require the clock correction logic to recognize a byte sequence that can be freely repeated or omitted in the incoming data stream. This sequence is generally an IDLE sequence, or other sequence comprised of special values that occur in the gaps separating packets of meaningful data. These gaps are required to occur sufficiently often to facilitate the timely execution of clock correction.

Channel Bonding

Some gigabit I/O standards such as Infiniband specify the use of multiple transceivers in parallel for even higher data rates. Words of data are split into bytes, with each byte sent over a separate channel (transceiver). See Figure 13.

3-State Buffers

Introduction

Each Virtex-II Pro CLB contains two 3-state drivers (TBUFs) that can drive on-chip buses. Each 3-state buffer has its own 3-state control pin and its own input pin.

Each of the four slices have access to the two 3-state buffers through the switch matrix, as shown in Figure 45. TBUFs in neighboring CLBs can access slice outputs by direct connects. The outputs of the 3-state buffers drive horizontal routing resources used to implement 3-state buses.

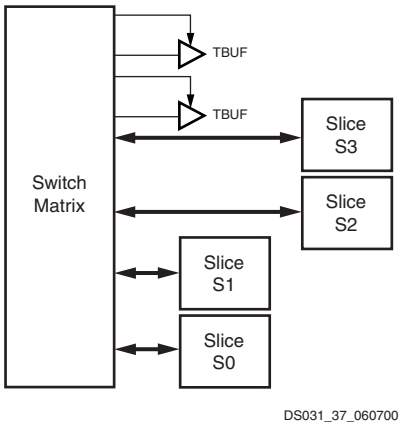

Figure 45: **Virtex-II Pro 3-State Buffers**

The 3-state buffer logic is implemented using AND-OR logic rather than 3-state drivers, so that timing is more predictable and less load dependant especially with larger devices.

Locations / Organization

Four horizontal routing resources per CLB are provided for on-chip 3-state buses. Each 3-state buffer has access alternately to two horizontal lines, which can be partitioned as shown in Figure 46. The switch matrices corresponding to SelectRAM+ memory and multiplier or I/O blocks are skipped.

Number of 3-State Buffers

Table 18 shows the number of 3-state buffers available in each Virtex-II Pro device. The number of 3-state buffers is twice the number of CLB elements.

Table 18: **Virtex-II Pro 3-State Buffers**

Device	3-State Buffers per Row	Total Number of 3-State Buffers
XC2VP2	44	704
XC2VP4	44	1,504
XC2VP7	68	2,464
XC2VP20	92	4,640
XC2VPX20	92	4,896
XC2VP30	92	6,848
XC2VP40	116	9,696
XC2VP50	140	11,808
XC2VP70	164	16,544
XC2VPX70	164	16,544
XC2VP100	188	22,048

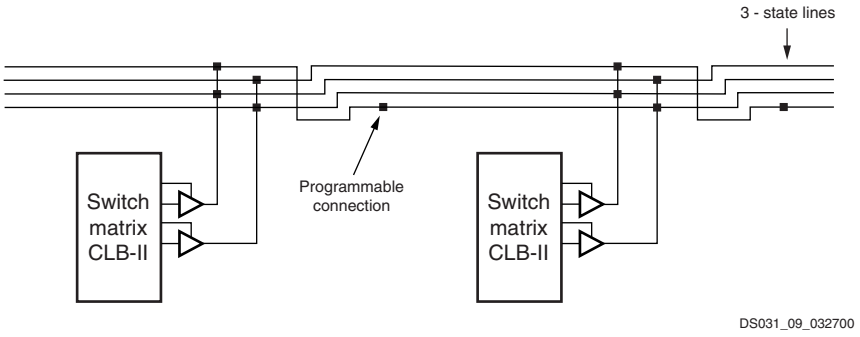

Figure 46: **3-State Buffer Connection to Horizontal Lines**

IOB Input Switching Characteristics

Input delays associated with the pad are specified for LVCMOS 2.5V levels. For other standards, adjust the delays with the values shown in IOB Input Switching Characteristics Standard Adjustments.

Table 35: **IOB Input Switching Characteristics**

			Speed Grade			
Description	**Symbol**	**Device**	**-7**	**-6**	**-5**	**Units**
Propagation Delays						
Pad to I output, no delay	T_{IOPI}	All	0.84	0.87	0.91	ns, max
Pad to I output, with delay	T_{IOPID}	XC2VP2	1.84	1.94	2.06	ns, max
		XC2VP4	1.84	1.94	2.06	ns, max
		XC2VP7	1.84	1.94	2.06	ns, max
		XC2VP20	2.14	2.23	2.37	ns, max
		XC2VPX20	2.14	2.23	2.37	ns, max
		XC2VP30	2.14	2.26	2.46	ns, max
		XC2VP40	2.54	2.67	2.81	ns, max
		XC2VP50	2.54	2.68	2.87	ns, max
		XC2VP70	2.54	2.72	2.91	ns, max
		XC2VPX70	2.54	2.72	2.91	ns, max
		XC2VP100	N/A	4.71	4.80	ns, max
Propagation Delays						
Pad to output IQ via transparent latch, no delay	T_{IOPLI}	All	0.86	0.89	0.93	ns, max
Pad to output IQ via transparent latch, with delay	T_{IOPLID}	XC2VP2	2.30	2.62	2.97	ns, max
		XC2VP4	2.57	2.89	3.23	ns, max
		XC2VP7	2.50	2.84	3.17	ns, max
		XC2VP20	2.65	3.04	3.42	ns, max
		XC2VPX20	2.65	3.04	3.42	ns, max
		XC2VP30	2.69	3.12	3.51	ns, max
		XC2VP40	3.30	3.63	4.03	ns, max
		XC2VP50	3.86	4.10	4.45	ns, max
		XC2VP70	4.00	4.25	4.57	ns, max
		XC2VPX70	4.00	4.25	4.57	ns, max
		XC2VP100	N/A	6.50	7.06	ns, max
Clock CLK to output IQ	T_{IOCKIQ}	All	0.60	0.60	0.67	ns, max

Table 38: **IOB Output Switching Characteristics Standard Adjustments *(Continued)***

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-7	-6	-5	
HSTL, Class II	HSTL_II	T_{OHSTL_II}	0.30	0.35	0.38	ns
HSTL, Class III	HSTL_III	T_{OHSTL_IIII}	0.31	0.35	0.39	ns
HSTL, Class IV	HSTL_IV	T_{OHSTL_IV}	0.15	0.17	0.19	ns
HSTL, Class I, 1.8V	HSTL_I_18	$T_{OHSTL\_I\_18}$	0.56	0.64	0.70	ns
HSTL, Class II, 1.8V	HSTL_II_18	$T_{OHSTL\_II\_18}$	0.30	0.35	0.38	ns
HSTL, Class III, 1.8V	HSTL_III_18	$T_{OHSTL\_IIII\_18}$	0.36	0.41	0.45	ns
HSTL, Class IV, 1.8V	HSTL_IV_18	$T_{OHSTL\_IV\_18}$	0.19	0.22	0.24	ns
SSTL (Stub Series Terminated Logic), Class I, 1.8V	SSTL18_I	$T_{OSSTL18\_I}$	0.80	0.92	1.01	ns
SSTL, Class II, 1.8V	SSTL18_II	$T_{OSSTL18\_II}$	0.45	0.51	0.56	ns
SSTL, Class I, 2.5V	SSTL2_I	T_{OSSTL2_I}	0.63	0.72	0.79	ns
SSTL, Class II, 2.5V	SSTL2_II	T_{OSSTL2_II}	0.22	0.25	0.27	ns
LVDCI (Low-Voltage Digitally Controlled Impedance), 3.3V	LVDCI_33	T_{OLVDCI_33}	0.72	0.83	0.91	ns
LVDCI, 2.5V	LVDCI_25	T_{OLVDCI_25}	0.56	0.64	0.71	ns
LVDCI, 1.8V	LVDCI_18	T_{OLVDCI_18}	0.65	0.75	0.82	ns
LVDCI, 1.5V	LVDCI_15	T_{OLVDCI_15}	1.00	1.15	1.26	ns
LVDCI, 2.5V, Half-Impedance	LVDCI_DV2_25	$T_{OLVDCI\_DV2\_25}$	0.06	0.07	0.08	ns
LVDCI, 1.8V, Half-Impedance	LVDCI_DV2_18	$T_{OLVDCI\_DV2\_18}$	0.30	0.34	0.38	ns
LVDCI, 1.5V, Half-Impedance	LVDCI_DV2_15	$T_{OLVDCI\_DV2\_15}$	0.60	0.69	0.76	ns
HSLVDCI (High-Speed Low-Voltage DCI), 1.5V	HSLVDCI_15	$T_{OHSLVDCI\_15}$	1.00	1.15	1.26	ns
HSLVDCI, 1.8V	HSLVDCI_18	$T_{OHSLVDCI\_18}$	0.65	0.75	0.82	ns
HSLVDCI, 2.5V	HSLVDCI_25	$T_{OHSLVDCI\_25}$	0.56	0.64	0.71	ns
HSLVDCI, 3.3V	HSLVDCI_33	$T_{OHSLVDCI\_33}$	0.72	0.83	0.91	ns
GTL (Gunning Transceiver Logic) with DCI	GTL_DCI	T_{OGTL_DCI}	1.21	1.39	1.53	ns
GTL Plus with DCI	GTLP_DCI	T_{OGTLP_DCI}	0.05	0.06	0.07	ns
HSTL (High-Speed Transceiver Logic), Class I, with DCI	HSTL_I_DCI	$T_{OHSTL\_I\_DCI}$	0.55	0.63	0.69	ns
HSTL, Class II, with DCI	HSTL_II_DCI	$T_{OHSTL\_II\_DCI}$	0.47	0.54	0.60	ns
HSTL, Class III, with DCI	HSTL_III_DCI	$T_{OHSTL\_III\_DCI}$	0.31	0.36	0.40	ns
HSTL, Class IV, with DCI	HSTL_IV_DCI	$T_{OHSTL\_IV\_DCI}$	1.81	2.08	2.29	ns
HSTL, Class I, 1.8V, with DCI	HSTL_I_DCI_18	$T_{OHSTL\_I\_DCI\_18}$	0.55	0.63	0.70	ns
HSTL, Class II, 1.8V, with DCI	HSTL_II_DCI_18	$T_{OHSTL\_II\_DCI\_18}$	0.24	0.28	0.31	ns
HSTL, Class III, 1.8V, with DCI	HSTL_III_DCI_18	$T_{OHSTL\_III\_DCI\_18}$	0.35	0.40	0.44	ns
HSTL, Class IV, 1.8V, with DCI	HSTL_IV_DCI_18	$T_{OHSTL\_IV\_DCI\_18}$	1.48	1.70	1.87	ns
SSTL (Stub Series Terminated Logic), Class I, 1.8V, with DCI	SSTL18_I_DCI	$T_{OSSTL18\_I\_DCI}$	0.54	0.62	0.68	ns
SSTL, Class II, 1.8V, with DCI	SSTL18_II_DCI	$T_{OSSTL18\_II\_DCI}$	0.24	0.28	0.31	ns
SSTL, Class I, 2.5V, with DCI	SSTL2_I_DCI	$T_{OSSTL2\_I\_DCI}$	0.48	0.56	0.61	ns
SSTL, Class II, 2.5V, with DCI	SSTL2_II_DCI	$T_{OSSTL2\_II\_DCI}$	0.48	0.56	0.61	ns

Block SelectRAM+ Switching Characteristics

Table 47: **Block SelectRAM+ Switching Characteristics**

Description	Symbol	Speed Grade			Units
		-7	-6	-5	
Sequential Delays					
Clock CLK to DOUT output	T_{BCKO}	1.41	1.50	1.68	ns, max
Setup and Hold Times Before Clock CLK					
ADDR inputs	T_{BACK}/T_{BCKA}	0.27/ 0.22	0.31/ 0.25	0.35/ 0.28	ns, min
DIN inputs	T_{BDCK}/T_{BCKD}	0.20/ 0.22	0.23/ 0.25	0.26/ 0.28	ns, min
EN input	T_{BECK}/T_{BCKE}	0.28/ 0.00	0.32/ 0.00	0.35/ 0.00	ns, min
RST input	T_{BRCK}/T_{BCKR}	0.28/ 0.00	0.32/ 0.00	0.35/ 0.00	ns, min
WEN input	T_{BWCK}/T_{BCKW}	0.33/ 0.00	0.35/ 0.00	0.39/ 0.00	ns, min
Clock CLK					
CLKA to CLKB setup time for different ports	T_{BCCS}	1.0	1.0	1.0	ns, min
Minimum Pulse Width, High	T_{BPWH}	1.17	1.30	1.50	ns, min
Minimum Pulse Width, Low	T_{BPWL}	1.17	1.30	1.50	ns, min

Notes:
1. A Zero “0” Hold Time listing indicates no hold time or a negative hold time. Negative values can not be guaranteed “best-case”, but if a “0” is listed, there is no positive hold time.

TBUF Switching Characteristics

Table 48: **TBUF Switching Characteristics**

Description	Symbol	Speed Grade			Units
		-7	-6	-5	
Combinatorial Delays					
IN input to OUT output	T_{IO}	0.88	1.01	1.12	ns, max
TRI input to OUT output high-impedance	T_{OFF}	0.48	0.55	0.61	ns, max
TRI input to valid data on OUT output	T_{ON}	0.48	0.55	0.61	ns, max

Table 5: **FG256/FGG256 — XC2VP2 and XC2VP4**

Bank	Pin Description	Pin Number
1	IO_L02N_1	C13
1	IO_L02P_1	B14
1	IO_L01N_1/VRP_1	C14
1	IO_L01P_1/VRN_1	C15
2	IO_L01N_2/VRP_2	E14
2	IO_L01P_2/VRN_2	E15
2	IO_L02N_2	E13
2	IO_L02P_2	F12
2	IO_L03N_2	F13
2	IO_L03P_2	F14
2	IO_L04N_2/VREF_2	F15
2	IO_L04P_2	F16
2	IO_L06N_2	G13
2	IO_L06P_2	G14
2	IO_L85N_2	G15
2	IO_L85P_2	G16
2	IO_L86N_2	G12
2	IO_L86P_2	H13
2	IO_L88N_2/VREF_2	H14
2	IO_L88P_2	H15
2	IO_L90N_2	H16
2	IO_L90P_2	J16
3	IO_L90N_3	J15
3	IO_L90P_3	J14
3	IO_L89N_3	J13
3	IO_L89P_3	K12
3	IO_L87N_3/VREF_3	K16
3	IO_L87P_3	K15
3	IO_L85N_3	K14
3	IO_L85P_3	K13
3	IO_L06N_3	L16
3	IO_L06P_3	L15
3	IO_L05N_3	L14

Table 6: **FG456/FGG456 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
0	VCCO_0	G9			
0	VCCO_0	G11			
0	VCCO_0	G10			
0	VCCO_0	F8			
0	VCCO_0	F7			
1	VCCO_1	G14			
1	VCCO_1	G13			
1	VCCO_1	G12			
1	VCCO_1	F16			
1	VCCO_1	F15			
2	VCCO_2	L16			
2	VCCO_2	K16			
2	VCCO_2	J16			
2	VCCO_2	H17			
2	VCCO_2	G17			
3	VCCO_3	T17			
3	VCCO_3	R17			
3	VCCO_3	P16			
3	VCCO_3	N16			
3	VCCO_3	M16			
4	VCCO_4	U16			
4	VCCO_4	U15			
4	VCCO_4	T14			
4	VCCO_4	T13			
4	VCCO_4	T12			
5	VCCO_5	U8			
5	VCCO_5	U7			
5	VCCO_5	T9			
5	VCCO_5	T11			
5	VCCO_5	T10			
6	VCCO_6	T6			
6	VCCO_6	R6			
6	VCCO_6	P7			
6	VCCO_6	N7			
6	VCCO_6	M7			
7	VCCO_7	L7			

FF672 Flip-Chip Fine-Pitch BGA Package

As shown in Table 8, XC2VP2, XC2VP4, and XC2VP7 Virtex-II Pro devices are available in the FF672 flip-chip fine-pitch BGA package. Pins in each of these devices are the same, except for differences shown in the "No Connects" column. Following this table are the FF672 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch).

Table 8: **FF672 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
0	IO_L01N_0/VRP_0	B24			
0	IO_L01P_0/VRN_0	A24			
0	IO_L02N_0	D21			
0	IO_L02P_0	C21			
0	IO_L03N_0	E20			
0	IO_L03P_0/VREF_0	D20			
0	IO_L05_0/No_Pair	F19			
0	IO_L06N_0	E19			
0	IO_L06P_0	E18			
0	IO_L07N_0	D19			
0	IO_L07P_0	C19			
0	IO_L08N_0	B19			
0	IO_L08P_0	A19			
0	IO_L09N_0	G18			
0	IO_L09P_0/VREF_0	F18			
0	IO_L37N_0	D18	NC	NC	
0	IO_L37P_0	C18	NC	NC	
0	IO_L38N_0	G17	NC	NC	
0	IO_L38P_0	H16	NC	NC	
0	IO_L39N_0	F17	NC	NC	
0	IO_L39P_0	F16	NC	NC	
0	IO_L43N_0	E17	NC	NC	
0	IO_L43P_0	D17	NC	NC	
0	IO_L44N_0	G16	NC	NC	
0	IO_L44P_0	G15	NC	NC	
0	IO_L45N_0	E16	NC	NC	
0	IO_L45P_0/VREF_0	D16	NC	NC	
0	IO_L67N_0	F15			
0	IO_L67P_0	E15			
0	IO_L68N_0	D15			
0	IO_L68P_0	C15			
0	IO_L69N_0	H15			
0	IO_L69P_0/VREF_0	H14			

Table 8: **FF672 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
4	IO_L05_4/No_Pair	Y8			
4	IO_L06N_4/VRP_4	AB8			
4	IO_L06P_4/VRN_4	AB9			
4	IO_L07N_4	AC8			
4	IO_L07P_4/VREF_4	AD8			
4	IO_L08N_4	AE8			
4	IO_L08P_4	AF8			
4	IO_L09N_4	Y9			
4	IO_L09P_4/VREF_4	AA9			
4	IO_L37N_4	AC9	NC	NC	
4	IO_L37P_4	AD9	NC	NC	
4	IO_L38N_4	Y10	NC	NC	
4	IO_L38P_4	W11	NC	NC	
4	IO_L39N_4	AA10	NC	NC	
4	IO_L39P_4	AA11	NC	NC	
4	IO_L43N_4	AB10	NC	NC	
4	IO_L43P_4	AC10	NC	NC	
4	IO_L44N_4	Y11	NC	NC	
4	IO_L44P_4	Y12	NC	NC	
4	IO_L45N_4	AB11	NC	NC	
4	IO_L45P_4/VREF_4	AC11	NC	NC	
4	IO_L67N_4	AA12			
4	IO_L67P_4	AB12			
4	IO_L68N_4	AC12			
4	IO_L68P_4	AD12			
4	IO_L69N_4	W12			
4	IO_L69P_4/VREF_4	W13			
4	IO_L73N_4	Y13			
4	IO_L73P_4	AA13			
4	IO_L74N_4/GCLK3S	AB13			
4	IO_L74P_4/GCLK2P	AC13			
4	IO_L75N_4/GCLK1S	AD13			
4	IO_L75P_4/GCLK0P	AE13			
5	IO_L75N_5/GCLK7S	AE14			
5	IO_L75P_5/GCLK6P	AD14			
5	IO_L74N_5/GCLK5S	AC14			

Table 9: **FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30**

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
1	IO_L54N_1		G13	NC		
1	IO_L54P_1		H13	NC		
1	IO_L53_1/No_Pair		A10	NC		
1	IO_L50_1/No_Pair		B10	NC		
1	IO_L49N_1		F14	NC		
1	IO_L49P_1		G14	NC		
1	IO_L48N_1		F12	NC		
1	IO_L48P_1		F11	NC		
1	IO_L47N_1		B9	NC		
1	IO_L47P_1		C9	NC		
1	IO_L46N_1		E13	NC		
1	IO_L46P_1		E12	NC		
1	IO_L45N_1/VREF_1		G12			
1	IO_L45P_1		H12			
1	IO_L44N_1		A8			
1	IO_L44P_1		B8			
1	IO_L43N_1		D11			
1	IO_L43P_1		E11			
1	IO_L39N_1		G11			
1	IO_L39P_1		H11			
1	IO_L38N_1		C8			
1	IO_L38P_1		D8			
1	IO_L37N_1		D10			
1	IO_L37P_1		E10			
1	IO_L09N_1/VREF_1		G10			
1	IO_L09P_1		H10			
1	IO_L08N_1		C7			
1	IO_L08P_1		D7			
1	IO_L07N_1		F10			
1	IO_L07P_1		F9			
1	IO_L06N_1		G9			
1	IO_L06P_1		H9			
1	IO_L05_1/No_Pair		G8			
1	IO_L03N_1/VREF_1		E9			
1	IO_L03P_1		E8			
1	IO_L02N_1		F8			

Table 9: **FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30**

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
2	IO_L41N_2		L8	NC		
2	IO_L41P_2		L7	NC		
2	IO_L42N_2		H4	NC		
2	IO_L42P_2		H3	NC		
2	IO_L43N_2		H2			
2	IO_L43P_2		J2			
2	IO_L44N_2		M8			
2	IO_L44P_2		M7			
2	IO_L45N_2		K6			
2	IO_L45P_2		K5			
2	IO_L46N_2/VREF_2		J1			
2	IO_L46P_2		K1			
2	IO_L47N_2		M6			
2	IO_L47P_2		M5			
2	IO_L48N_2		J4			
2	IO_L48P_2		J3			
2	IO_L49N_2		K2			
2	IO_L49P_2		L2			
2	IO_L50N_2		N8			
2	IO_L50P_2		N7			
2	IO_L51N_2		K4			
2	IO_L51P_2		K3			
2	IO_L52N_2/VREF_2		L1			
2	IO_L52P_2		M1			
2	IO_L53N_2		N6			
2	IO_L53P_2		N5			
2	IO_L54N_2		L5			
2	IO_L54P_2		L4			
2	IO_L55N_2		M2			
2	IO_L55P_2		N2			
2	IO_L56N_2		P9			
2	IO_L56P_2		R9			
2	IO_L57N_2		M4			
2	IO_L57P_2		M3			
2	IO_L58N_2/VREF_2		N1			
2	IO_L58P_2		P1			

FF1152 Flip-Chip Fine-Pitch BGA Package

As shown in Table 10, XC2VP20, XC2VP30, XC2VP40, and XC2VP50 Virtex-II Pro devices are available in the FF1152 flip-chip fine-pitch BGA package. Pins in each of these devices are the same, except for the differences shown in the No Connect column. Following this table are the FF1152 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch).

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
0	IO_L01N_0/VRP_0	E29				
0	IO_L01P_0/VRN_0	E28				
0	IO_L02N_0	H26				
0	IO_L02P_0	G26				
0	IO_L03N_0	H25				
0	IO_L03P_0/VREF_0	G25				
0	IO_L05_0/No_Pair	J25				
0	IO_L06N_0	K24				
0	IO_L06P_0	J24				
0	IO_L07N_0	F26				
0	IO_L07P_0	E26				
0	IO_L08N_0	D30				
0	IO_L08P_0	D29				
0	IO_L09N_0	K23				
0	IO_L09P_0/VREF_0	J23				
0	IO_L19N_0	F24	NC	NC		
0	IO_L19P_0	E24	NC	NC		
0	IO_L20N_0	D28	NC	NC		
0	IO_L20P_0	C28	NC	NC		
0	IO_L21N_0	H24	NC	NC		
0	IO_L21P_0	G24	NC	NC		
0	IO_L25N_0	G23	NC	NC		
0	IO_L25P_0	F23	NC	NC		
0	IO_L26N_0	E27	NC	NC		
0	IO_L26P_0	D27	NC	NC		
0	IO_L27N_0	K22	NC	NC		
0	IO_L27P_0/VREF_0	J22	NC	NC		
0	IO_L37N_0	H22				
0	IO_L37P_0	G22				
0	IO_L38N_0	D26				
0	IO_L38P_0	C26				
0	IO_L39N_0	K21				
0	IO_L39P_0	J21				
0	IO_L43N_0	F22				

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
4	IO_L73P_4	AG17				
4	IO_L74N_4/GCLK3S	AH17				
4	IO_L74P_4/GCLK2P	AJ17				
4	IO_L75N_4/GCLK1S	AK17				
4	IO_L75P_4/GCLK0P	AL17				
5	IO_L75N_5/GCLK7S	AL18				
5	IO_L75P_5/GCLK6P	AK18				
5	IO_L74N_5/GCLK5S	AJ18				
5	IO_L74P_5/GCLK4P	AH18				
5	IO_L73N_5	AG18				
5	IO_L73P_5	AF18				
5	IO_L69N_5/VREF_5	AL19				
5	IO_L69P_5	AK19				
5	IO_L68N_5	AJ19				
5	IO_L68P_5	AH19				
5	IO_L67N_5	AE18				
5	IO_L67P_5	AD18				
5	IO_L57N_5/VREF_5	AL20				
5	IO_L57P_5	AL21				
5	IO_L56N_5	AJ20				
5	IO_L56P_5	AH20				
5	IO_L55N_5	AG19				
5	IO_L55P_5	AF19				
5	IO_L54N_5	AM22				
5	IO_L54P_5	AM21				
5	IO_L53_5/No_Pair	AK21				
5	IO_L50_5/No_Pair	AJ21				
5	IO_L49N_5	AE19				
5	IO_L49P_5	AD19				
5	IO_L48N_5	AL23				
5	IO_L48P_5	AL22				
5	IO_L47N_5	AH21				
5	IO_L47P_5	AG21				
5	IO_L46N_5	AF20				
5	IO_L46P_5	AE20				
5	IO_L45N_5/VREF_5	AM24				
5	IO_L45P_5	AL24				

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
6	IO_L01P_6/VRN_6	AJ30				
6	IO_L01N_6/VRP_6	AJ31				
6	IO_L02P_6	AJ27				
6	IO_L02N_6	AJ28				
6	IO_L03P_6	AK31				
6	IO_L03N_6/VREF_6	AK32				
6	IO_L04P_6	AH29				
6	IO_L04N_6	AH30				
6	IO_L05P_6	AH27				
6	IO_L05N_6	AG28				
6	IO_L06P_6	AL33				
6	IO_L06N_6	AL34				
6	IO_L15P_6	AG29	NC			
6	IO_L15N_6/VREF_6	AG30	NC			
6	IO_L16P_6	AK33	NC			
6	IO_L16N_6	AK34	NC			
6	IO_L17P_6	AF27	NC			
6	IO_L17N_6	AF28	NC			
6	IO_L18P_6	AJ33	NC			
6	IO_L18N_6	AJ34	NC			
6	IO_L19P_6	AH31	NC			
6	IO_L19N_6	AH32	NC			
6	IO_L20P_6	AD25	NC			
6	IO_L20N_6	AD26	NC			
6	IO_L21P_6	AG31	NC			
6	IO_L21N_6/VREF_6	AG32	NC			
6	IO_L22P_6	AF29	NC			
6	IO_L22N_6	AF30	NC			
6	IO_L23P_6	AE27	NC			
6	IO_L23N_6	AE28	NC			
6	IO_L24P_6	AH33	NC			
6	IO_L24N_6	AH34	NC			
6	IO_L31P_6	AF31				
6	IO_L31N_6	AF32				
6	IO_L32P_6	AC25				
6	IO_L32N_6	AC26				
6	IO_L33P_6	AG33				
6	IO_L33N_6/VREF_6	AG34				

Table 11: **FF1148 — XC2VP40 and XC2VP50**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
2	IO_L40P_2	K3		
2	IO_L41N_2	R9		
2	IO_L41P_2	P9		
2	IO_L42N_2	K1		
2	IO_L42P_2	K2		
2	IO_L43N_2	L5		
2	IO_L43P_2	L6		
2	IO_L44N_2	P7		
2	IO_L44P_2	P8		
2	IO_L45N_2	L1		
2	IO_L45P_2	L2		
2	IO_L46N_2/VREF_2	M5		
2	IO_L46P_2	M6		
2	IO_L47N_2	R10		
2	IO_L47P_2	R11		
2	IO_L48N_2	M3		
2	IO_L48P_2	M4		
2	IO_L49N_2	M1		
2	IO_L49P_2	M2		
2	IO_L50N_2	R7		
2	IO_L50P_2	T8		
2	IO_L51N_2	P4		
2	IO_L51P_2	N4		
2	IO_L52N_2/VREF_2	N2		
2	IO_L52P_2	N3		
2	IO_L53N_2	T10		
2	IO_L53P_2	T11		
2	IO_L54N_2	P5		
2	IO_L54P_2	P6		
2	IO_L55N_2	R3		
2	IO_L55P_2	P3		
2	IO_L56N_2	T6		
2	IO_L56P_2	T7		
2	IO_L57N_2	P1		
2	IO_L57P_2	P2		
2	IO_L58N_2/VREF_2	R5		
2	IO_L58P_2	R6		
2	IO_L59N_2	U10		

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
4	IO_L38P_4	AH16		
4	IO_L39N_4	AR14		
4	IO_L39P_4	AP14		
4	IO_L43N_4	AU14		
4	IO_L43P_4	AT14		
4	IO_L44N_4	AH17		
4	IO_L44P_4	AG17		
4	IO_L45N_4	AN15		
4	IO_L45P_4/VREF_4	AM15		
4	IO_L46N_4	AR15		
4	IO_L46P_4	AP15		
4	IO_L47N_4	AK16		
4	IO_L47P_4	AJ17		
4	IO_L48N_4	AU15		
4	IO_L48P_4	AT15		
4	IO_L49N_4	AM16		
4	IO_L49P_4	AL16		
4	IO_L50_4/No_Pair	AM17		
4	IO_L53_4/No_Pair	AL17		
4	IO_L54N_4	AP16		
4	IO_L54P_4	AN17		
4	IO_L55N_4	AR16		
4	IO_L55P_4	AR17		
4	IO_L56N_4	AH18		
4	IO_L56P_4	AG18		
4	IO_L57N_4	AU17		
4	IO_L57P_4/VREF_4	AT17		
4	IO_L58N_4	AM18		
4	IO_L58P_4	AL18		
4	IO_L59N_4	AK18		
4	IO_L59P_4	AJ18		
4	IO_L60N_4	AP18		
4	IO_L60P_4	AN18		
4	IO_L64N_4	AT18		
4	IO_L64P_4	AR18		
4	IO_L65N_4	AH19		
4	IO_L65P_4	AG19		
4	IO_L66N_4	AU18		

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
N/A	VCCAUX	AP6		
N/A	VCCAUX	F6		
N/A	VCCAUX	AR5		
N/A	VCCAUX	E5		
N/A	VCCAUX	AW2		
N/A	VCCAUX	Y2		
N/A	VCCAUX	A2		
N/A	VCCAUX	AV1		
N/A	VCCAUX	AA1		
N/A	VCCAUX	Y1		
N/A	VCCAUX	W1		
N/A	VCCAUX	B1		
N/A	GND	A3		
N/A	GND	AV2		
N/A	GND	AU2		
N/A	GND	AA2		
N/A	GND	W2		
N/A	GND	C2		
N/A	GND	B2		
N/A	GND	AU1		
N/A	GND	AM1		
N/A	GND	AH1		
N/A	GND	AD1		
N/A	GND	T1		
N/A	GND	M1		
N/A	GND	H1		
N/A	GND	C1		
N/A	GND	AD5		
N/A	GND	T5		
N/A	GND	M5		
N/A	GND	H5		
N/A	GND	AU4		
N/A	GND	AT4		
N/A	GND	D4		
N/A	GND	C4		
N/A	GND	AW3		
N/A	GND	AV3		

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
0	IO_L11N_0	M25	NC
0	IO_L11P_0	M26	NC
0	IO_L12N_0	F26	NC
0	IO_L12P_0	G26	NC
0	IO_L18N_0	B26	NC
0	IO_L18P_0/VREF_0	C26	NC
0	IO_L46N_0	G24	
0	IO_L46P_0	G25	
0	IO_L47N_0	K26	
0	IO_L47P_0	L26	
0	IO_L48N_0	E25	
0	IO_L48P_0	F25	
0	IO_L49N_0	C24	
0	IO_L49P_0	C25	
0	IO_L50_0/No_Pair	L24	
0	IO_L53_0/No_Pair	L25	
0	IO_L54N_0	A25	
0	IO_L54P_0	B25	
0	IO_L55N_0	H23	
0	IO_L55P_0	H24	
0	IO_L56N_0	J25	
0	IO_L56P_0	K25	
0	IO_L57N_0	E24	
0	IO_L57P_0/VREF_0	F24	
0	IO_L58N_0	D23	
0	IO_L58P_0	D24	
0	IO_L59N_0	J24	
0	IO_L59P_0	K24	
0	IO_L60N_0	A24	
0	IO_L60P_0	B24	
0	IO_L64N_0	F23	
0	IO_L64P_0	G23	
0	IO_L65N_0	M22	
0	IO_L65P_0	M23	
0	IO_L66N_0	B23	
0	IO_L66P_0/VREF_0	C23	
0	IO_L67N_0	H22	

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
5	IO_L10N_5	AW27	NC
5	IO_L10P_5	AW26	NC
5	IO_L45N_5/VREF_5	AN27	
5	IO_L45P_5	AP27	
5	IO_L44N_5	AU27	
5	IO_L44P_5	AV27	
5	IO_L43N_5	AR27	
5	IO_L43P_5	AR26	
5	IO_L39N_5	AL27	
5	IO_L39P_5	AM27	
5	IO_L38N_5	BA28	
5	IO_L38P_5	BB28	
5	IO_L37N_5	AY28	
5	IO_L37P_5	AY27	
5	IO_L87N_5/VREF_5	AN28	
5	IO_L87P_5	AP28	
5	IO_L86N_5	AU28	
5	IO_L86P_5	AV28	
5	IO_L85N_5	AT28	
5	IO_L85P_5	AT27	
5	IO_L84N_5	AL28	
5	IO_L84P_5	AM28	
5	IO_L83_5/No_Pair	BA29	
5	IO_L80_5/No_Pair	BB29	
5	IO_L79N_5	AY29	
5	IO_L79P_5	AW28	
5	IO_L78N_5	AN29	
5	IO_L78P_5	AP29	
5	IO_L77N_5	AU29	
5	IO_L77P_5	AV29	
5	IO_L76N_5	AT29	
5	IO_L76P_5	AR28	
5	IO_L36N_5/VREF_5	AL29	
5	IO_L36P_5	AM29	
5	IO_L35N_5	AY30	
5	IO_L35P_5	BA30	
5	IO_L34N_5	AT30	

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
N/A	VCCINT	W16	
N/A	VCCINT	V16	
N/A	VCCINT	U16	
N/A	VCCINT	T16	
N/A	VCCINT	R16	
N/A	VCCINT	P16	
N/A	VCCINT	AJ15	
N/A	VCCINT	AH15	
N/A	VCCINT	R15	
N/A	VCCINT	P15	
N/A	VCCINT	AJ14	
N/A	VCCINT	P14	
N/A	VCCINT	AK13	
N/A	VCCINT	N13	
N/A	VCCAUX	BA42	
N/A	VCCAUX	AY42	
N/A	VCCAUX	AL42	
N/A	VCCAUX	AB42	
N/A	VCCAUX	AA42	
N/A	VCCAUX	M42	
N/A	VCCAUX	C42	
N/A	VCCAUX	B42	
N/A	VCCAUX	BB41	
N/A	VCCAUX	A41	
N/A	VCCAUX	BB40	
N/A	VCCAUX	A40	
N/A	VCCAUX	BB31	
N/A	VCCAUX	A31	
N/A	VCCAUX	BB22	
N/A	VCCAUX	A22	
N/A	VCCAUX	BB21	
N/A	VCCAUX	A21	
N/A	VCCAUX	BB12	
N/A	VCCAUX	A12	
N/A	VCCAUX	BB3	
N/A	VCCAUX	A3	
N/A	VCCAUX	BB2	